


# 16.3" HMI

## *Product Specification*

Customer		
Product Number	<b>DM-163GN-MPYR01</b>	
Customer Part Number		
Customer Approval	Date:	

Internal Approvals		
Product Mgr	ME. Eng	Electr. Eng
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Date: May 12, 2020	Date: May 12, 2020	Date: May 12, 2020

## Revision Record

Rev.	Date	Page	Chapt.	Comment	ECR no.
1.0	May 12, 2020	-	-	Release MP spec.	-

# Table of Contents

16.3" HMI.....	1
<b>PRODUCT SPECIFICATION .....</b>	<b>1</b>
<b>1. GENERAL DESCRIPTION .....</b>	<b>5</b>
1.1 INTRODUCTION .....	5
1.2 MAIN FEATURES .....	ERROR! BOOKMARK NOT DEFINED.
<b>2. HMI DESIGN .....</b>	<b>6</b>
2.1 BLOCK DIAGRAM .....	6
2.2 MECHANICAL DRAWING.....	6
2.3 HMI SPECIFICATION .....	10
2.4 MECHANICAL SPECIFICATION .....	11
2.5 TOUCH SPECIFICATION .....	11
<b>3. ELECTRICAL SPECIFICATION .....</b>	<b>12</b>
3.1 MAXIMUM RATINGS .....	12
<b>4. OPTICAL SPECIFICATION.....</b>	<b>13</b>
4.1 OPTICAL CHARACTERISTICS .....	13
<b>5. PACKAGING.....</b>	<b>14</b>
5.1 LABELLING AND MARKING .....	14
5.2 OSD MARKING FOR I/O .....	15
<b>6. ENVIRONMENTAL SPECIFICATION.....</b>	<b>18</b>
<b>7. ACCESSARY .....</b>	<b>18</b>
<b>8. CERTIFICATION.....</b>	<b>19</b>
<b>9. QUALITY ASSURANCE SPECIFICATION .....</b>	<b>20</b>
9.1 CONFORMITY .....	20
9.2 ENVIRONMENT REQUIRED .....	20
9.3 DELIVERY ASSURANCE .....	20
<b>10. DEALING WITH CUSTOMER COMPLAINT .....</b>	<b>23</b>
10.1 NON-CONFORMING ANALYSIS.....	23
10.2 HANDLING OF NON-CONFORMING DISPLAYS.....	23
<b>11. HANDLING PRECAUTIONS .....</b>	<b>24</b>
11.1 HANDLING PRECAUTIONS.....	24

11.2 STORAGE PRECAUTIONS .....25

11.3 DESIGNING PRECAUTIONS .....25

11.4 OPERATION PRECAUTIONS .....25

11.5 OTHER PRECAUTIONS .....26

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# 1. General Description

## 1.1 Introduction

Densitron's modular design of HMI control surface is suitable for applications in Broadcast, Telecommunications, and other networked control and monitoring systems.

This universal touchscreen control surface is 2RU rack mountable, with an embedded ARM platform and Ethernet connectivity.

The display has 1920 x 285 pixels and an optically bonded capacitive touchscreen providing optimum optical quality. The display features wide-angle symmetric viewing making it easier to be used in many operational applications.

The embedded ARM platform is Densitron's Aurora SBX™ single board computer based on NXP i.MX6 utilising Quad core ARM® Cortex-A9 2GHz. The APU paired with onboard DDR3 RAM provides the performance to support contemporary multi-media requirements, and rich User Interfaces.

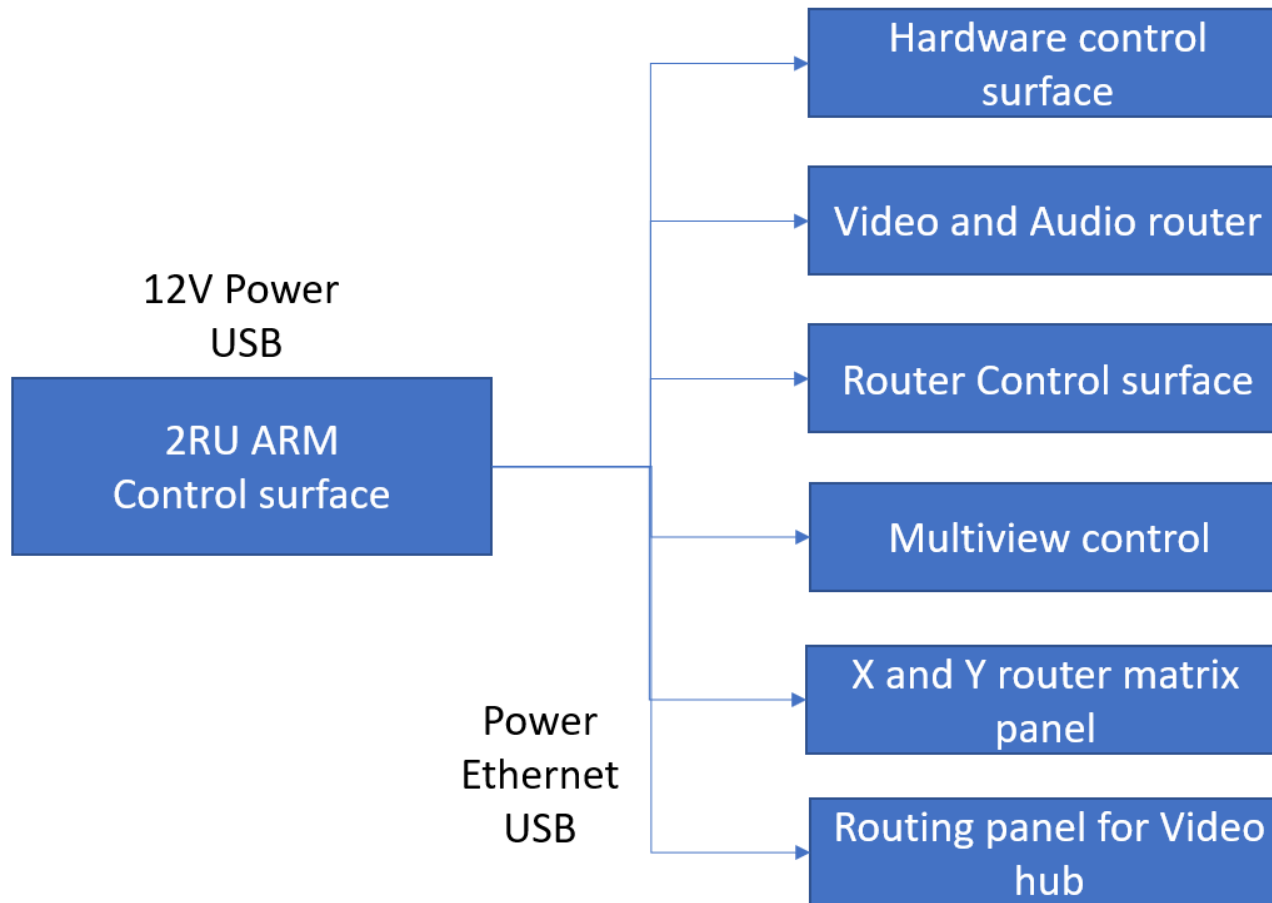
The embedded Aurora Software Ecosystem (ASE) allows for rapid development of user's HMI applications.

## Product Features

- Packaged into a single **2RU 19"** rack metal chassis
- Ethernet LAN up to 1Gbps
- Single 12V power supply
- NXP i.MX6 Quad core APU - 4x ARM® Cortex®-A9 up to 1.0 GHz with 2GB RAM
- uSD card Embedded Linux BSP (Aurora ASE)
- Display resolution of **1920 x 285** pixels with 24-bit colour depth of 16.4M colours
- **800cd/m<sup>2</sup>** peak luminance and adjustable backlight
- Utilising MVA technology which offers **89/89/89/89** symmetric viewing
- These TFT modules are designed to operate continuously with backlight half-life of **50k** hours and a temperature range of **0°C to +50°C**
- UReady family offers optically bonded Projected Capacitive Touch (PCT) as standard
- "Out-of-the-box" development environment in virtual machine with Qt library Open Source (ASE), allowing cross compiling for faster development (supplied on 32GB USB dongle)
- Browser application (Firefox or Chromium) for rapid deployment of existing UIs and server-side functionality

## 2. HMI Design

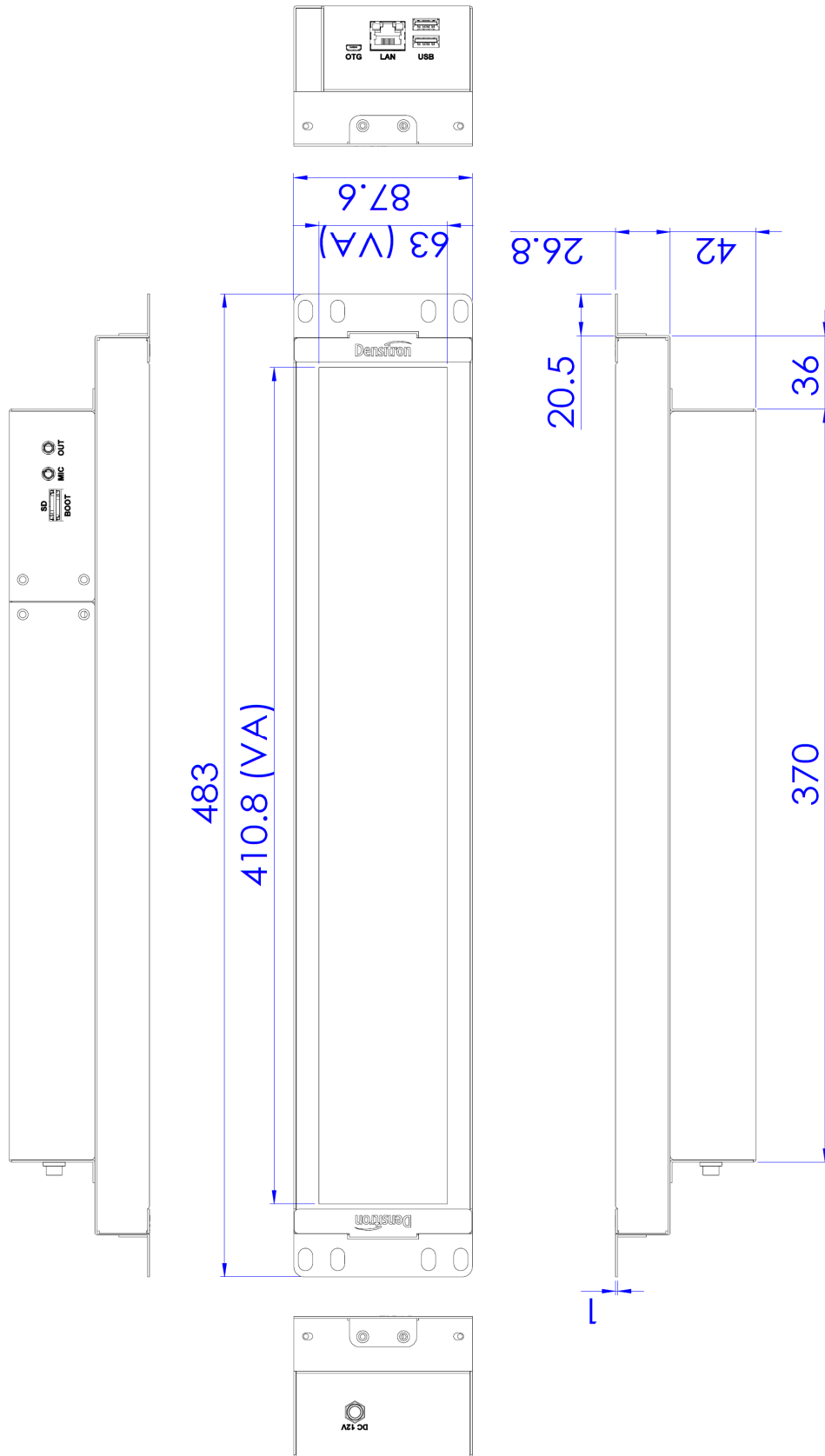
### 2.1 Application Block Diagram



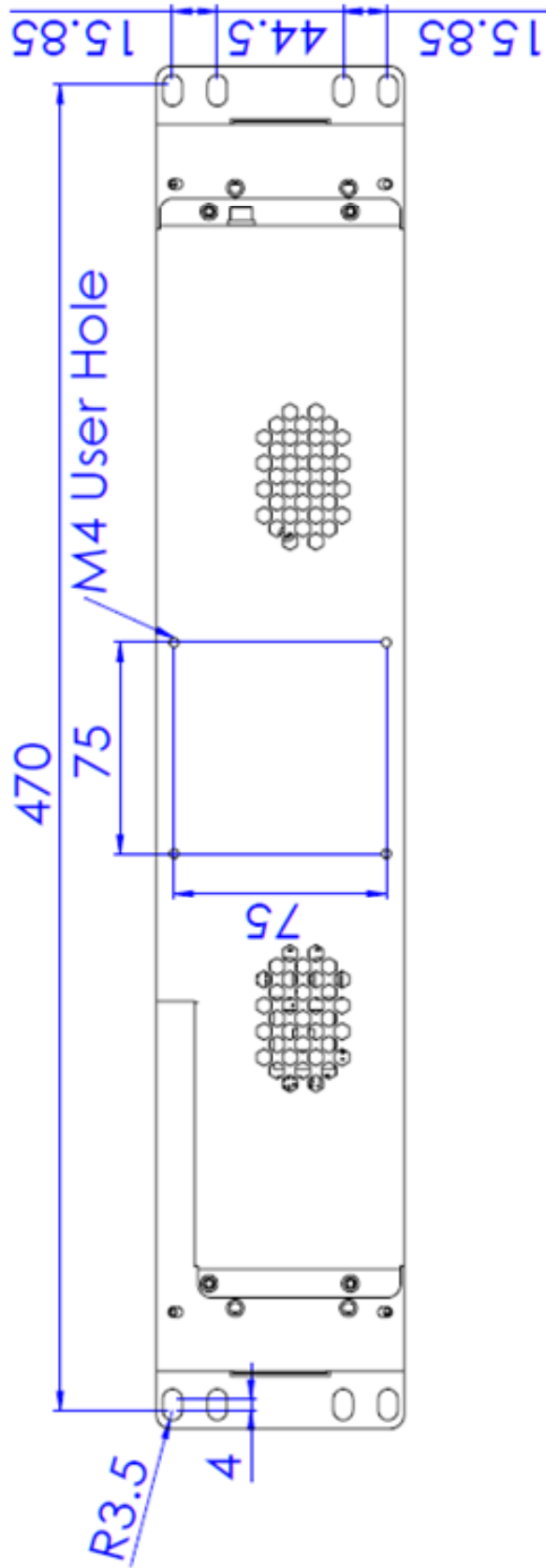
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## 2.2 Mechanical Drawing









## 2.3 HMI Specification

Component	Function	Densitron Proposed	
Computer board	Processor	NXP I.MX6 Quad core	
	DDR3	2 GB DDR3-1600	
	Storage	µSD Card	
	Lan	Ethernet: 10/100/1000 Mbps x 1	
	Audio	Line-out(left/right channels) x 1, Mic-in x 1	
	I/O(external)		USB OTG x 1
			µSD Card x 1
			Ethernet: 10/100/1000 Mbps x 1
			USB2.0 x 2
			12V DC IN Jack
	GPU		3D GPU - Vivante GC2000 (supports OpenGL ES 3.0 and Halti)
			2D GPU (Vector) – Vivante GC335 (supports Open VG 1.1)
			2D GPU (Composition) – Vivante GC320
		Hardware Video Decoding	
Panel	Type	TFT LCD	
	Viewing angle	178(H)/178(V)	
	Size	16.3” bar cut suitable for 19” rack	
	Resolution	1920*285 Pixels	
	Brightness	700 nits (typ.)	
	PPI	119	
Touch	Type	PCAP multi touch	

## 2.4 Mechanical Specification

Mechanical Specification	
Structure	HMI embedded design
Chassis	2U Rack mount HMI
Mounting	Rack mount
Thermal	Fanless, Heatsink type
Labelling	(To be discussed with customer)
Dimension	483x 87.6 x 68.8 mm
Weight	2 KG
VESA	75x75
Packaging	2 units in one box, EPE foam

## 2.5 Touch Specification

Touch Type	PCAP
Touch Structures	Cover glass + Glass(G/G)
Cover Glass	1.1 mm
Touch point	Multi touch points (up to 10 fingers)
Interface	USB HID
Bonding Technology	Optical Bonding
Surface Hardness	6H
Treatment	Chemical Hardening, Anti-Glare

## 3. Electrical Specification

### 3.1 Maximum Ratings

Item	Symbol	Min	Max	Unit	Note
Supply Voltage for Operation	V <sub>CC</sub>	10.8	13.2	V	-
Operating Current for VCC	I <sub>CC</sub>	-	2.5	A	1
Operating Temperature	T <sub>op</sub>	0	50	°C	-
Static Electricity	IEC 61000-4-2				-

Note:

- 1) Maximum operating current is determined with the stress test software running and no external devices connected. Reference PSU (Power Supply Unit) Stontronics TS877ST.

## 4. Optical Specification

### 4.1 Optical Characteristics

Characteristics		Symbol	Conditions	Min	Typ	Max	Unit
Contrast Ratio		CR	-	-	1000:1	-	-
Response time		TR + TF		-	20	40	ms
Viewing Angle	Left/ Right	-	CR>10	-	178	-	deg
	Up/ Down	-		-	178	-	
Colour Chromaticity	Red	Rx	-	-0.05	0.640	+0.05	-
		Ry			0.330		
	Green	Gx			0.300		
		Gy			0.660		
	Blue	Bx			0.140		
		By			0.060		
	White	Wx			0.299		
		Wy			0.315		
Brightness		-	Default: 100 W/ Touch	540	700	-	cd/m <sup>2</sup>

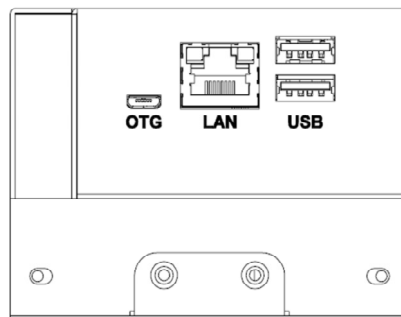
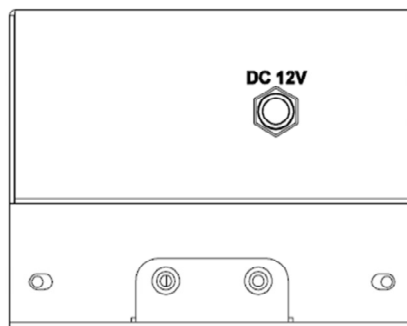
## 5. Packaging

### 5.1 Labelling and Marking

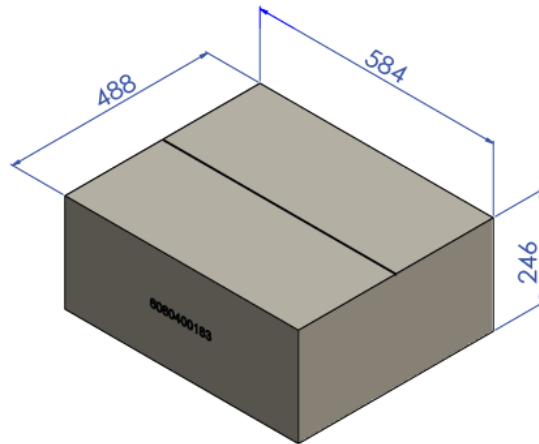


Densitron  
www.densitron.com  
**DM-163GN-MPYR01 9959163000**  
16.3" HMI  
Panel, PCAP , optical bonding , Aurora board  
S510202020001-2013-0024

## 5.2 OSD Marking for I/O



### 5.3 Packaging



Out box

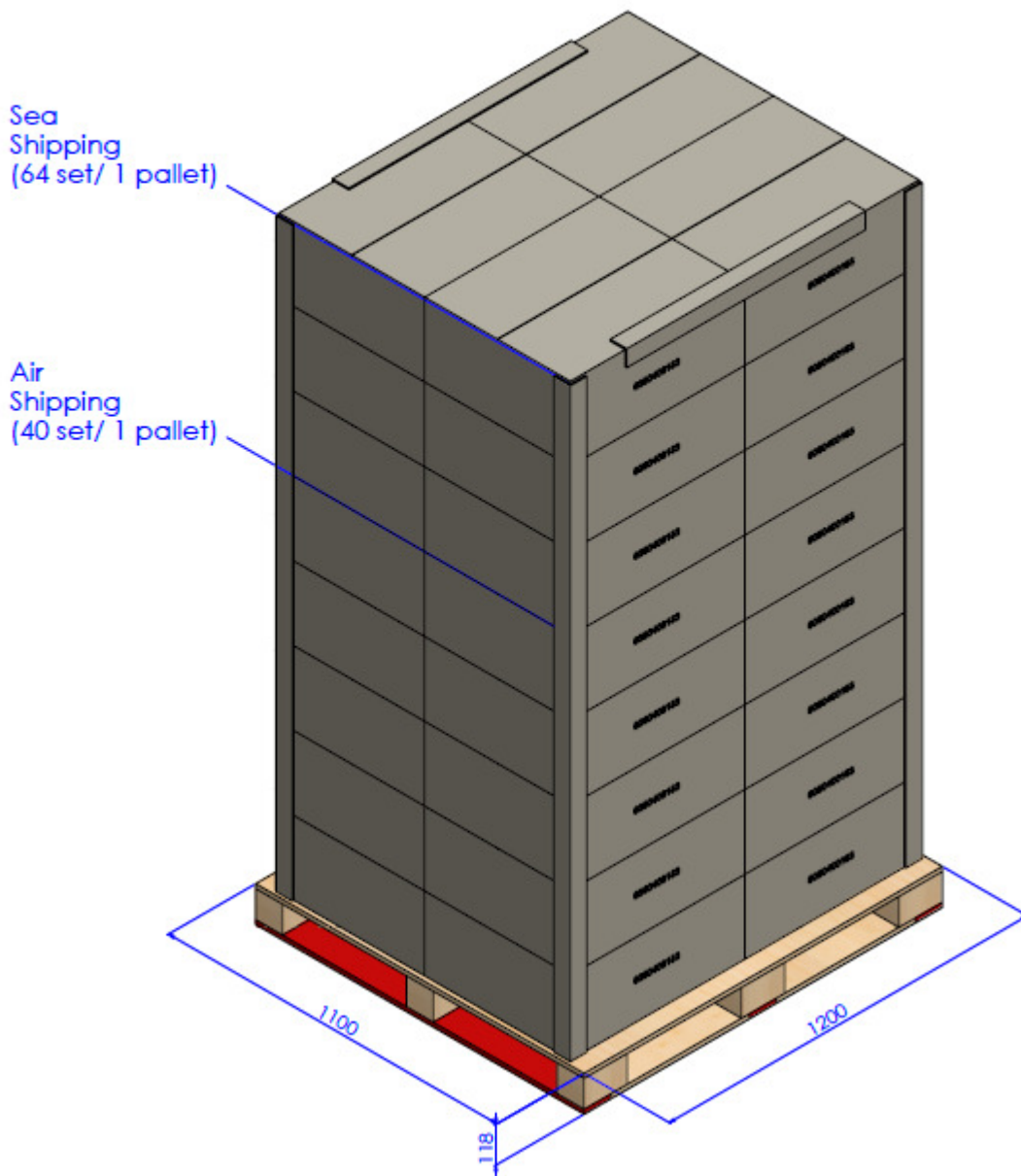


Accessory box





Pallet information



## 6. Environmental Specification

Environmental specification	
Operating Temperature	0 ~ 50 degree Celsius
Storage Temperature	-10 ~ 55 degree Celsius
Relative Humidity	95%@40 degree Celsius, non-condensing
Operating Vibration	1 Grms/5~500Hz, IEC 60068-2-64
Non-Operating Shock	30 Grms, 11ms, IEC 60068-2-27
ESD Protection	8kV contact/15kV air
EMI	FCC class A testing

## 7. Accessory

Ethernet 5M cable \* 1 / per one product  
 40 W power supplier \* 1 / per one product  
 Power cord \* 1 / per one product

## 8. Certification

CE Standard:

EN 55032:2015+AC:2016 Class A

EN IEC 61000-3-2:2019 Class D

EN 61000-3-3:2013+A1:2019

EN 55024:2010+A1:2015

LVD Standard

IEC 62368-1 :2014 (Second Edition)

EN 62368-1:2014+A11:2017 (Second Edition)

FCC standards:

FCC Rule Part(s): FCC Part 15 Subpart B Class A

ISED Standard(s): ICES-003 Issue 6:2016 (updated April 2019) Class A

Measurement Procedure(s): ANSI C63.4-2014

## 9. Quality Assurance Specification

### 9.1 Conformity

These inspection standards shall be applied to Stretched LCD Panel.

### 9.2 Environment Required

Customer's test & measurement are required to be conducted under the following conditions:

Ambient Temperature: 20 ~ 25 ° C

Humidity: 60 ~ 70% RH

Ambient Illumination: Fluorescent light (Day-Light type) display surface illumination to be 300~700Lux (standard 500Lux)

Viewing distance: 30 - 40cm from the surface of the monitor

Viewing Angle: 45 degree to the front surface of display panel.

Inspection resolution 1920 ×285

Finger glove (or finger cover) must be worn by the inspector.

Inspection table or jig must be anti-electrostatic.

### 9.3 Delivery Assurance

#### 9.3.1 Criteria & Acceptable Quality Level (MIL-STD-105E, Level II)

Partition	AQL	Definition
Major	0.65	Defects in Pattern Check (Display On)
Minor	1.5	Defects in Cosmetic Check (Display Off)

#### 9.3.2 Packing Inspection

No.	Items	Criteria	Inspection equipment
1	Carton Label	The character (Model, P/N, S/N etc...) can be discerned.	Visual
2	Box	No broken and dirty	

### 9.3.3 Appearance Inspection of Monitor

No.	Items	Criteria	Inspection equipment
1	Rear & Side	No crack, broken and distortion	* Visual * Calipers * Steel scale
2	Rear Label	The character (Model, P/N, S/N etc...) can be discerned.	
3	Dimension size	Tolerance: $\pm 1.0\text{mm}$	

### 9.3.4 LCD Visual Inspection

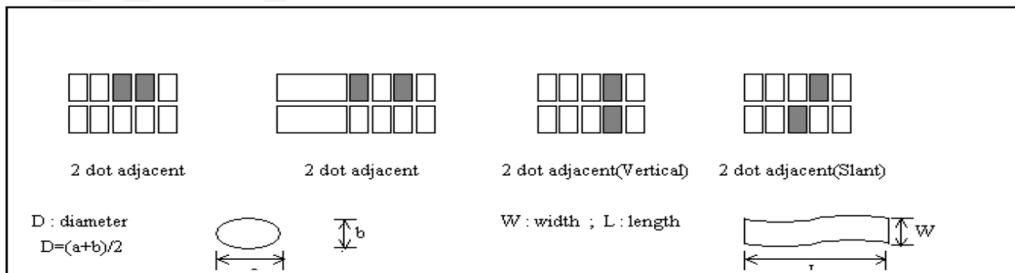
Units: mm

Item		Standard		Inspection equipment
Dot (Bright)	Random		$N \leq 2$	* PC for inspection * Pattern generator * Lupe: $\times 10$ * Test program
	2 adjacent		$N \leq 1$	
Dot (Dark)	Random		$N \leq 3$	
	2 adjacent		$N \leq 1$	
Total		$N \leq 5$		
Particles	Circular	$0.15 < D \leq 0.5\text{mm}$ , $N \leq 4$		
	Linear	$0.07 < W$ , $2.0 < L$ , $N = 0$		
Scratch/ Dent	Circular	$0.15 < D \leq 0.5\text{mm}$ , $N \leq 4$		
	Linear	$0.07 < W$ , $2.0 < L$ , $N = 5$		
Bubble	Circular	$0.15 < D \leq 0.5\text{mm}$ , $N \leq 4$		
Mura		Use 5% ND filter or judged by equivalent limit sample		
Line defect		Not allowed		

Note:

- 1) Diameter, W: Width, L: Length, N: Count
- 2) Distance between 2 Bright dots:  $\geq 15\text{mm}$
- 3) Distance between 2 Dark dots:  $\geq 15\text{mm}$
- 4) Distance between Bright and Dark dot:  $\geq 15\text{mm}$

#### Note (1) Two dot adjacent



### 9.3.5 Function Inspection

#### 9.3.5.1 LCD Luminance and colour chromaticity

- 1) Measure point: Center of screen
- 2) Colure: White pattern
- 3) Stability time: 30 minutes

Item	Standard	Inspection equipment
Luminance	Typ. 700cd/m <sup>2</sup> Min. 560cd/m <sup>2</sup>	* Colour analyser: CA-310 * PC * A/D Board
Colure	White x: 0.299 +/- 0.05 White y: 0.315 +/- 0.05	

#### 9.3.5.2 Display inspection

Item	Standard	Inspection equipment
Colure	No strange colure displaying	* PC * A/D Board
Flicker	No flicker	

#### 9.3.5.3 Touch Visual Inspection

Units: mm

Item	Standard	Inspection equipment
Particles	D≤0.2mm, 5mm≤distance, Ignored 0.2<D≤0.4mm, 20mm≤distance, N≤4 0.4<D≤0.5mm, 20mm≤distance, N≤2	
Scratch	W≤0.2mm, L<20mm, 20mm≤distance N≤5 W≤0.1mm, L<8mm, 20mm≤distance N≤2 W>0.2mm, L>10mm, NG	
Bubble	D<0.1mm, Ignored W≤1/2X, L≤1mm, Ignored D>0.2mm, NG	
Linear defect	W<0.1mm, L≤10mm, Ignored W<0.2mm, L≤10mm, N≤10 W>0.2mm, L>10mm, NG	

## 10. Dealing with Customer Complaint

### 10.1 Non-conforming Analysis

Purchaser should supply Densitron with detailed data of non-conforming sample.

After accepting it, Densitron should complete the analysis in two weeks from receiving the sample. If the analysis cannot be completed on time, Densitron must inform the purchaser.

### 10.2 Handling of Non-conforming Displays

If any non-conforming displays are found during customer acceptance inspection which Densitron is clearly responsible for, return them to Densitron.

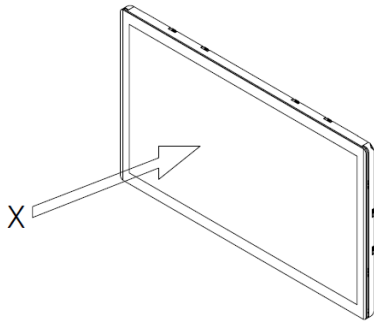
Both Densitron and customer should analyse the reason and discuss the handling of non-conforming displays when the reason is not clear.

Equally, both sides should discuss and come to agreement for issues pertaining to modification of Densitron quality assurance standard.

## 11. Handling Precautions

### 11.1 Handling Precautions

- 1) Since the display panel is made of glass, do not apply mechanical impacts such as dropping from a high position.
- 2) If the display panel is broken by accident and the internal organic substance leaks out, be careful not to inhale nor lick the organic substance.
- 3) If the liquid crystal touches your skin or clothes, wash it off immediately using soap and plenty of water.
- 4) If pressure is applied to the display surface or its neighbourhood of the display module, the cell structure may be damaged, care must be used not to apply pressure to these sections.
- 5) Applicable only for non-touch screen products: The polarizer covering the surface of the display module is soft and easily scratched. Please be careful when handling the display module.
- 6) Hold the display module very carefully when placing it into the system housing. Do not apply excessive stress or pressure to display module. And, do not excessively bend the film with electrode pattern layouts. These stresses will influence the display performance. Also, ensure sufficient rigidity for the outer cases.



- 7) Do not apply stress to the LSI chips and the surrounding moulded sections.
- 8) Do not disassemble nor modify the display module.
- 9) Do not apply input signals while the logic power is off.
- 10) Pay sufficient attention to the working environments when handling display modules to prevent breakage of element through static electricity. Use electrostatic prevention.
  - a. Human body to be grounded when handling display modules.
  - b. Be sure to ground tools to use or assembly such as soldering irons.
  - c. To suppress generation of static electricity, avoid carrying out assembly work under dry environments.
  - d. Protective film is being applied to the surface of the display module, this may create static electricity when peeling off the protective film.
- 11) Protection film is being applied to the surface of the display panel and removes the protection film before assembling it. If the display module has been stored for a long period of time, residue adhesive material of the protection film may remain on the surface of the display panel after removed of the film. In such case, remove the residue material by the method introduced in the above Section 5).
- 12) If electric current is applied when the display module has condensation or when it is placed under high humidity environments, the electrodes may be corroded. Be careful to avoid the Condensation.



## 11.2 Storage Precautions

- 1) When storing display modules, put them in static electricity preventive bags avoiding exposure to direct sun light nor to lights of fluorescent lamps, etc. and, also, avoiding high temperature and high humidity environments or low temperature (less than 0°C) environments. (We recommend you to store these modules in the packaged state when they were shipped from Densitron) At that time, be careful not to let water drops adhere to the packages or bags nor let dewing occur with them.
- 2) If electric current is applied when water drops are adhering to the surface of the display module, when the display module is being dewed or when it is placed under high humidity environments, the electrodes may be corroded and be careful about the above.

## 11.3 Designing Precautions

- 1) The absolute maximum ratings are the ratings which cannot be exceeded for display module, and if these values are exceeded, panel damage may be happen. Exceeding maximum ratings will void Warrantee.
- 2) To prevent occurrence of malfunctioning by noise, pay attention to satisfy the VIL and VIH specifications and, at the same time, to make the signal line cable as short as possible.
- 3) We recommend you install excess current preventive unit (fuses, etc.) to the power circuit (VDD). (Recommend value: 0.5A)
- 4) Pay sufficient attention to avoid occurrence of crosstalk noise interference with the neighbouring devices.
- 5) As for EMI, take preventative measures on the equipment side.
- 6) When fastening the display module, fasten the external plastic housing section.
- 7) If power supply to the display module is forcibly shut down by such errors as taking out the main battery while the display panel is in operation, we cannot guarantee the quality of this display module.

## 11.4 Operation Precautions

- 1) It is essential to drive the display within the specified voltage limit since excessive voltage shortens its life.
- 2) Direct current causes an electrochemical reaction with rapid deterioration of the display quality. Give careful consideration to prevent direct current during ON/OFF timing and during operation.
- 3) Response time is extremely delayed at temperatures lower than the operating temperature range while, at high temperatures, displays become dark. However, this phenomenon is reversible and does not mean a malfunction or a display that has been permanently damaged.
- 4) To protect display modules from performance drops by static electricity rapture, etc., do not touch the following sections whenever possible while handling the display modules.
  - a. Pins and electrodes
  - b. Pattern layouts such as the FPC
- 5) When the driver is being exposed (COG), semiconductor elements change their characteristics when light is radiated according to the principle of the solar battery. Consequently, if the driver is exposed to light, malfunctioning may occur.
  - a. Design the product and installation method so that the driver may be shielded from light in actual usage.
  - b. Design the product and installation method so that the driver may be shielded from light during the inspection processes.

- 6) Although the display module stores the operation state data by the commands and the indication data, when excessive external noise, etc. enters into the module, the internal status may be changed. It therefore is necessary to take appropriate measures to suppress noise generation or to protect from influences of noise on the system design.
- 7) We recommend you design the software to make periodical refreshment of the operation statuses (re-setting of the commands and re-transference of the display data) to cope with catastrophic noise. Refer to recommended operating manual.

## 11.5 Other Precautions

- 1) Request that qualified companies handle industrial wastes when disposing of the display modules. Or, when burning them, be sure to observe the environmental and hygienic laws and regulations.

### Warning

Class I Equipment. This equipment must be earthed. The power plug must be connected to a properly wired earth ground socket outlet. An improperly wired socket outlet could place hazardous voltages on accessible metal parts.

"CAUTION: Risk of Explosion if Battery is replaced by an Incorrect Type. Dispose of Used Batteries According to the Instructions."

### CAUTION:

- Lithium Battery Caution: Danger of explosion if battery is incorrectly replaced. Replace only with same or an equivalent type. Dispose batteries according to manufacturer's instructions.
- Disposal of a BATTERY into fire or a hot oven, or mechanically crushing or cutting of a BATTERY, that can result in an EXPLOSION
- Leaving a BATTERY in an extremely high temperature surrounding environment that can result in an EXPLOSION or the leakage of flammable liquid or gas
- A BATTERY subjected to extremely low air pressure that may result in an EXPLOSION or the leakage of flammable liquid or gas.